03-15-2001



101637700

2/27/01

P/2292-37

## COVER SHEET

To the Assistant Commissioner of Patents and Trademarks: Please record the attached original document or copy there

1. Name of conveying party(ies):

2. Name and Address of receiving party(ies):

Chul Ju HWANG Sung Weon LEE Jusung Engineering Co., Ltd. 49, Neungpyeong-Ri, Opo-Myeun Kwangiu-Gun, Kyunggi-Do, Korea

Type of Entity: Individuals

Type of Entity: Corporation of Korea

Additional names(s) of conveying party(ies) attached?

Additional name(s) & address(es) attached?

No

3. Nature of Conveyance:

Assignment

**Execution Date:** 

February 22, 2001

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

February 22, 2001

A. Application No.(s)

B. Patent No.(s)

09293949

Additional numbers attached?

No

 Name and address of party to whom correspondence concerning document should be mailed:

6. Total number of documents involved:

1

OSTROLENK, FABER, GERB & SOFFEN, LLP 1180 Avenue of the Americas New York, New York 10036-8403

7. Total fee (37 CFR 3.41):

\$ 40.00

Enclosed as part of Check No.

3552

In the event the actual fee is greater than the payment submitted or is inadvertently not enclosed or if any additional fee due is not paid, the Patent and Trademark Office is authorized to charge the underpayment to Deposit Account No. 15-0700.

DO NOT USE THIS SPACE

8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Total number of pages including cover sheet, attachments,

Max Moskowitz

Name of Person Signing

February 27, 2001

Date

and document:

03/05/2001 HVUONG1 00000049 09793949

02 FC:581

40.00 DP

00496839.1

PATENT REEL: 011579 FRAME: 0378

WHEREAS, I (We), Chul Ju HWANG and Sung Weon LEE
as assignor(s), have invented certai
improvements in CLUSTER TOOL FOR FABRICATING SEMICONDUCTOR DEVICE
for which an application for United States Letters Patent has
been executed by me (us) of even date herewith; and
WHEREAS, JUSUNG ENGINEERING CO., LTD.
WHEREAS, UOSONG ENGINEERING CO., LID.
as assignee, is desirous of acquiring all right, title and interest in and to said
invention and any Patent that may be granted therefor.
Theneron and any racena enact may be granted ended to
NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and
valuable consideration, the receipt of which is hereby acknowledged, I (We), as
assignor(s), hereby sell, assign and set over to said assignee the entire right, title and
interest for the United States and all other countries in and to said invention and the
aforesaid application for Patent, all original, divisional, continuation, substitute or
reissue applications and patents applied for or granted therefor in the United States and
all other countries, including all rights of priority from the filing of said application,
and all rights for past infringement, and the Commissioner of Patents and Trademarks is
hereby authorized and requested to issue all patents on said inventions or resulting
therefrom to said assignee herein, as assignee of the entire interest therein; and the
undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns
do hereby agree and covenant without further remuneration, to execute and deliver all
divisional, continuation, reissue and other applications for Patent on said inventions and
all assignments thereof to said assignee or its assigns, to communicate to said assignee
or its representatives all facts known to the undersigned respecting said inventions,
whenever requested, to testify in any interferences or other legal proceedings in which
any of said applications or patents may become involved, to sign all lawful papers, make
all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the
Successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be
borne and paid by said assignee.
borne and pard by said assignee.
Date: 22. Feb. 2001
Date: 22. Reb. 200/ Sung-Weon Cel
$\mathcal{J}$
Date:
Date:
Date:

LEGALIZATION RECOMMENDED

**RECORDED: 02/27/2001** 

PATENT REEL: 011579 FRAME: 0379